

SPECIFICATION

Part No.	:	DBP.2450.X.A.30
Description	:	Dielectric Band Pass Filter for 2450MHz
		Bandwidth 100MHz
Features	:	Center Frequency 2450MHz
		Supports ISM 2450MHz
		Low Insertion Loss
		High Ultimate Attenuation
		Dims: 7.2*6.3*3mm





1. Introduction

Taoglas are utilizing their deep understanding of the RF component design and manufacturing process to provide high-quality, small-form-factor, cost-effective and easy to implement RF filters. The Taoglas Filters Division will feature a range of off-the-shelf filters for a variety of applications, including filters for emerging license free bands used for IoT and for GPS L1/L2 and L1/L5 applications. We can also work with customers to develop bespoke filter solutions.

Taoglas dielectric filters are designed to be used in wireless transmitters or receivers. These filters are designed to protect the LNA from noisy out of band emissions originated from nearby transmitters that can overdrive, or even damage your LNA. Overdriving the LNA results in non-linear distortion which negatively impacts the sensitivity of your receiver.

By selecting the proper Taoglas filter you can eliminate unnecessary out of band noise while maintaining minimal in-band insertion loss. The filter is manufactured as a single ceramic block [monoblock] which provides high reliability, low insertion loss and high attenuation in a simple compact SMD package.

The DBP.2450.X.A.30 is a standard Taoglas product but can be customized for specific customer needs. For more information please contact your regional sales office.



2. Specification

ELECTRICAL					
Centre Frequency (Fo)	2450MHz				
3dB Bandwidth	100MHz				
Insertion Loss	2.0 dB max				
Return Loss	< -10 dB				
	> 40.0 dB @ 0 ~ 2000MHz				
	> 30.0 dB @ 2000MHz ~ 2200MHz				
Attenuation	> 25.0 dB @ 2700MHz ~ 2900MHz				
	> 15.0 dB @ 2900MHz ~ 5000MHz				
In/Out Impedance	50 Ω				
Power Dissipation	1.0 W min.				
MECHANICAL					
Dimension	7.2*6.3*3mm (L*W*H)				
Material	Ceramic				
Finish	Ag plated				
ENVIRONMENTAL					
Operating Temperature	-40°C to 85°C				
Storage Temperature	-40°C to 85°C				



3. Characteristics Curve



3.1. Pass Band Return & Insertion Loss

3.2. Out-Of-Band Attenuation





4. Mechanical Drawings (Unit: mm)

4.1. Antenna Drawing





4.2. Recommended PCB Layout

4.2.1. Top Copper



4.2.2. Top Solder Paste



NOTE:

- 1. Ag Plated area
- Solder Mask area
 Copper area
- Copper area
 Paste area
- 5. Copper Keepout Area
- 6. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
- 7. The dimension tolerances should follow standard PCB manufacturing guidelines



4.2.3. Top Solder Mask



4.2.4. Composite Diagram



NOTE:

- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area5. Copper Keepout Area
- area 📕
- Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
 The dimension telepapers should follow standard DCP manufacturing
- 7. The dimension tolerances should follow standard PCB manufacturing guidelines



4.3. Evaluation Board



NOTE: 1.All material must be RoHS compliant.

	Name	Material	Finish	QTY
1	Filter	Ceramic	Clear	1
2	PCB	Composite 1.0t	Black	1
3	SMA(F) ST	Brass	Au Plated	2



5. Recommended Reflow Soldering Profile

Phase	Profile Features	Maximum
	Temperature Min	150°C
Preheat	Temperature Max	180°C
	Duration	60-120 sec
Ramp-Up	Avg. Ramp up rate	3°C/sec (max)
Deflow	Temperature	220°C
Reflow	Duration	30-40 sec
Peak	Temperature	265°C
Pedk	Duration	5 sec Max
Ramp Down	Avg. Ramp down rate	3°C/sec (max)





6. Packaging









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